

Date: 12-19-200

ASSISTANT COMMISSIONER FOR PATENTS

WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Gwo-Ji Horng, Jen-I Kuo, Feng-Ger Hsiau

For: METHOD OF FABRICATING A CERAMIC SUBSTRATE WITH A THERMAL CONDUCTIVE PLUG OF A MULTI-CHIP PACKAGE

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- Specification 25 pages.
- 4 Sheets of drawings
- Recordation Form Cover sheet with 2 pages assignment.
- A certified copy of Taiwan Patent Application No. __ dated _ .
- SIGNED declaration and power of attorney.
- Return Prepaid postcard.

CLAIMS AS FILED									
FOR	NUMB	ER FII	LED I	NUMBE	REXTRA	RATE	FEE		
Basic Fee						\$740.00	\$740.00		
Total Claims	49	_	20 =	29	×	\$18.00	\$522.00		
Independent Claims	7	_	3 =	4	×	\$84.00	\$336.00		
If application contains any multiple dependent claim (s), then add				\$280.00	\$0.00				
	TOTAL	FILINO	FEE				\$1,598.00		

A check in the amount of \$1598.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

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Assistant Commissioner for Patents Washington, D.C. 20231

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No.

: JCLA8482

Applicant(s)

: Gwo-Ji Horng, Jen-I Kuo, Feng-Ger Hsiau

For

: METHOD OF FABRICATING A CERAMIC SUBSTRATE WITH A THERMAL CONDUCTIVE PLUG OF A MULTI-CHIP

PACKAGE

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: December 19, 2001

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 25 pages, 4 sheets of drawings; SIGNED Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Michelle Chang